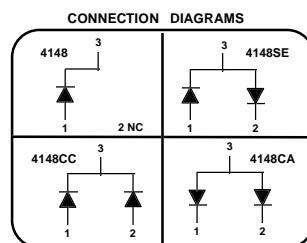
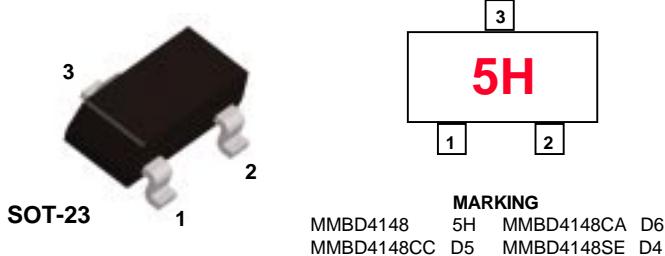


## MMBD4148 / SE / CC / CA



### High Conductance Ultra Fast Diode

Sourced from Process 1P. See MMBD1201-1205 for characteristics.

#### Absolute Maximum Ratings\*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
W <sub>IV</sub>	Working Inverse Voltage	75	V
I <sub>o</sub>	Average Rectified Current	200	mA
I <sub>F</sub>	DC Forward Current	600	mA
i <sub>f</sub>	Recurrent Peak Forward Current	700	mA
i <sub>f(surge)</sub>	Peak Forward Surge Current Pulse width = 1.0 second Pulse width = 1.0 microsecond	1.0 2.0	A A
T <sub>stg</sub>	Storage Temperature Range	-55 to +150	°C
T <sub>J</sub>	Operating Junction Temperature	150	°C

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

**NOTES:**

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

### Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
			MMBD4148/SE/CC/CA*
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	350 2.8	mW mW/C
R <sub>θJA</sub>	Thermal Resistance, Junction to Ambient	357	°C/W

\* Device mounted on glass epoxy PCB 1.6" X 1.6" X 0.06"; mounting pad for the collector lead min. 0.93 in<sup>2</sup>

## High Conductance Low Leakage Diode

(continued)

### Electrical Characteristics

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
$B_V$	Breakdown Voltage	$I_R = 100 \mu A$ $I_R = 5.0 \mu A$	100 75		V V
$I_R$	Reverse Current	$V_R = 20 V$ $V_R = 20 V, T_A = 150^\circ C$ $V_R = 75 V$		25 50 5.0	nA $\mu A$ $\mu A$
$V_F$	Forward Voltage	$I_F = 10 mA$		1.0	V
$C_O$	Diode Capacitance	$V_R = 0, f = 1.0 \text{ MHz}$		4.0	pF
$T_{RR}$	Reverse Recovery Time	$I_F = 10 mA, V_R = 6.0 V$ , $I_{RR} = 1.0 mA, R_L = 100\Omega$		4.0	nS